MOSFETs Silicon N-channel MOS (U-MOSVII-H)

TPWR8503NL

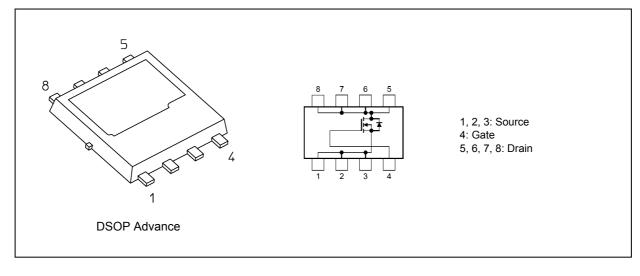
1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators

2. Features

- (1) High-speed switching
- (2) Small gate charge: $Q_{SW} = 16 \text{ nC}$ (typ.)
- (3) Low drain-source on-resistance: $R_{DS(ON)} = 1.0 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 4.5 \text{ V})$
- (4) Low leakage current: I_{DSS} = 10 μA (max) (V_{DS} = 30 V)
- (5) Enhancement mode: V_{th} = 1.3 to 2.3 V (V_{DS} = 10 V, I_D = 1.0 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (T_a = 25 °C unless otherwise specified)

Characteris	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	30	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)	(T _c = 25 °C) (Bottom drain)	(Note 1), (Note 2)	Ι _D	150	A
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	Ι _D	300	A
Drain current (pulsed)	(t = 100 μs)	(Note 1)	I _{DP}	500	A
Power dissipation	(T _c = 25 °C) (Bottom drain)		P _D	142	W
Power dissipation		(Note 3)	P _D	2.5	W
Power dissipation		(Note 4)	PD	0.8	W
Single-pulse avalanche energy		(Note 5)	E _{AS}	318	mJ
Single-pulse avalanche current		(Note 5)	I _{AS}	120	A
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristic	Symbol	Max	Unit		
Channel-to-case thermal resistance	Bottom drain (T _c = 25 °C)		R _{th(ch-c)}	0.88	°C/W
Channel-to-case thermal resistance	Top source (T _c = 25 °C)		R _{th(ch-c)}	0.93	°C/W
Channel-to-ambient thermal resistance	(T _a = 25 °C)	(Note 3)	R _{th(ch-a)}	50	°C/W
Channel-to-ambient thermal resistance	(T _a = 25 °C)	(Note 4)	R _{th(ch-a)}	156	°C/W

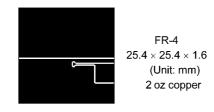
Note 1: Ensure that the channel temperature does not exceed 150 °C.

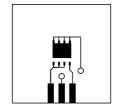
Note 2: Limited by package limit. Silicon chip capability is 300 A. ($T_c = 25 \text{ °C}$)

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

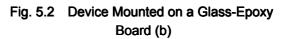
Note 5: V_{DD} = 24 V, T_{ch} = 25 °C (initial), L = 17 μ H, I_{AS} = 120 A





FR-4 25.4 × 25.4 × 1.6 (Unit: mm) 2 oz copper

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V			±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	30	_	_	V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	15	_	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1.0 mA	1.3		2.3	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 4.5 V, I _D = 50 A		1.0	1.3	mΩ
		V _{GS} = 10 V, I _D = 50 A		0.72	0.85	

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		5300	6900	pF
Reverse transfer capacitance	C _{rss}		_	130	—	
Output capacitance	C _{oss}			2700	_	
Gate resistance	r _g	—	_	1.2	1.8	Ω
Switching time (rise time)	t _r	See Fig. 6.2.1	_	9.6	_	ns
Switching time (turn-on time)	t _{on}			23	_	
Switching time (fall time)	t _f]		15	_	
Switching time (turn-off time)	t _{off}		_	89	_	

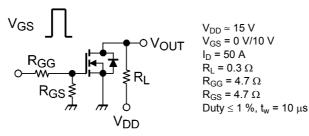


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

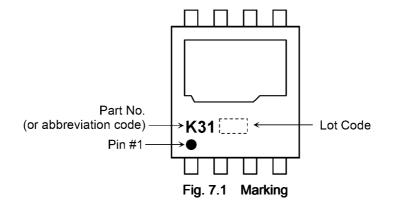
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Qg	$V_{DD}\approx 15~V,~V_{GS}$ = 10 V, I_{D} = 50 A	_	74	_	nC
gate-drain)		$V_{DD} \approx 15 \text{ V}, \text{ V}_{GS}$ = 4.5 V, I _D = 50 A	_	32	_	
Gate-source charge 1	Q _{gs1}	$V_{DD} \approx 15$ V, V_{GS} = 10 V, I_D = 50 A	_	19	_	
Gate-drain charge	Q _{gd}		_	6.5	_	
Gate switch charge	Q _{SW}		_	16	_	

6.4. Source-Drain Characteristics ($T_a = 25$ °C unless otherwise specified)

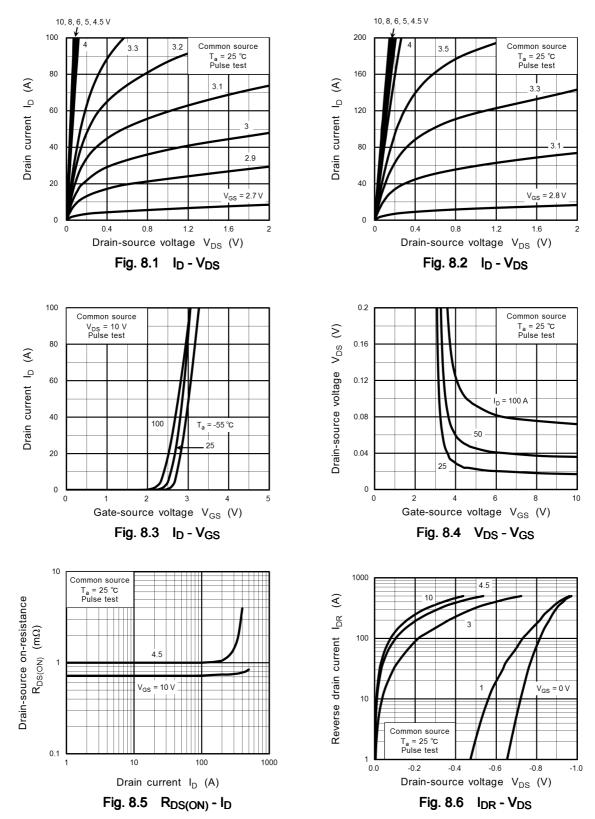
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 6)	I _{DRP} (t = 100 μs)	—	_		500	A
Diode forward voltage	V _{DSF}	I _{DR} = 150 A, V _{GS} = 0 V			-1.2	V
Reverse recovery time	t _{rr}	V _R = 15 V, I _{DR} = 37.5 A, V _{GS} =		58	_	ns
Reverse recovery charge	Q _{rr}	0 V, -dI _{DR} /dt = 100 A/μs		71	_	nC

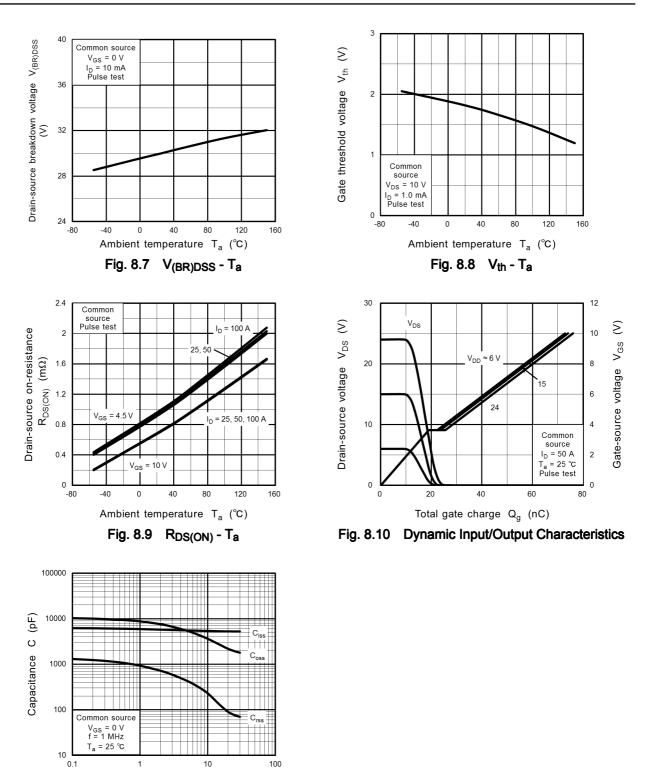
Note 6: Ensure that the channel temperature does not exceed 150 °C.

7. Marking



8. Characteristics Curves (Note)

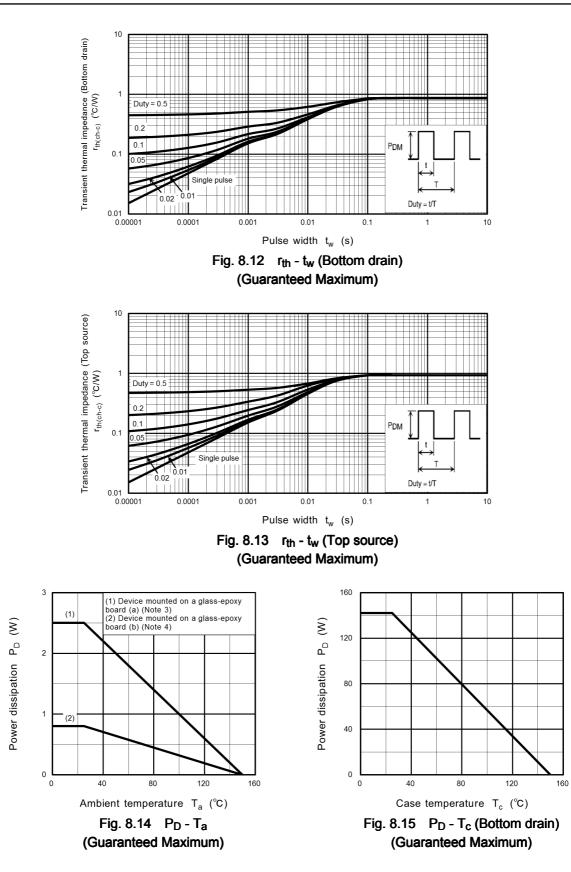


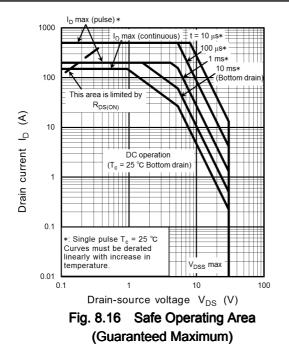


Drain-source voltage V_{DS} (V) Fig. 8.11 Capacitance - V_{DS}

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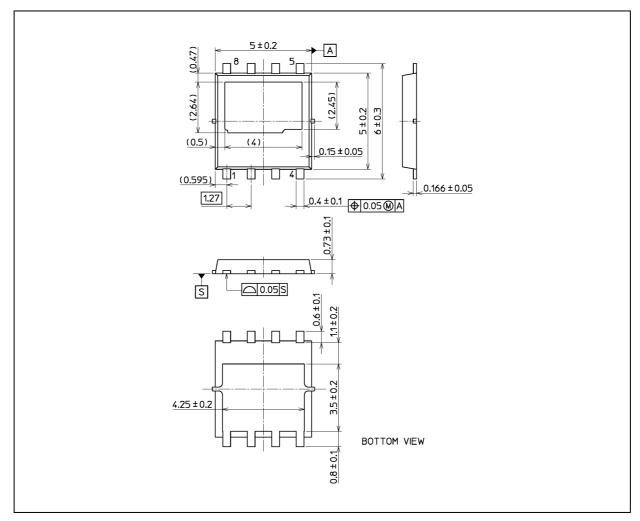


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

TPWR8503NL

Package Dimensions

Unit: mm



Weight: 0.104 g (typ.)

Package Name(s)

TOSHIBA: 2-5S1A

Nickname: DSOP Advance

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